SN74CBTS16211 24-BIT FET BUS SWITCH WITH SCHOTTKY DIODE CLAMPING SCDS050B – MARCH 1998 – REVISED MAY 1998

- 5-Ω Switch Connection Between Two Ports
- TTL-Compatible Input and Output Levels
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages

description

The SN74CBTS16211 provides 24 bits of high-speed TTL-compatible bus switching with Schottky diodes on the I/Os to clamp undershoot. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

The device can operate as a dual 12-bit bus switch or a single 24-bit bus switch. When $1\overline{OE}$ is low, 1A is connected to 1B. When $2\overline{OE}$ is low, 2A is connected to 2B.

The SN74CBTS16211 is characterized for operation from -40° C to 85° C.

FUNCTION TABLE (each 12-bit bus switch)

•					
	FUNCTION				
L	A port = B port				
н	Disconnect				

DGG, DGV, OR DL PACKAGE (TOP VIEW)						
		56	1 11 <u>0</u> E			
1A1	2					
1A2	3		1B1			
1A3 [4		1B2			
1A4 [5	52	П1В3			
1A5 [6		1B4			
1A6	7		1B5			
GND	8		GND			
1A7 🛛	9	48] 1B6			
1A8 🛛	10	47]1B7			
1A9 🛛	11	46]1B8			
1A10 🛛	12]1B9			
1A11 [13	44]1B10			
1A12 [14]1B11			
2A1 🛛	15	42]1B12			
2A2 🛛	16	41	2B1			
V _{CC}	17	40] 2B2			
2A3 🛛	18	39] 2B3			
	19	38] GND			
2A4 🛛	20	37	2B4			
2A5 🛛	21	36	2B5			
2A6 🛛	22	35	2B6			
2A7 🛛	23	34	2B7			
2A8 🛛	24	33	2B8			
2A9 🛛	25	32	E			
2A10	26	31	2B10			
2A11 [27	30	2B11			
2A12 🛛	28	29	2B12			

NC - No internal connection



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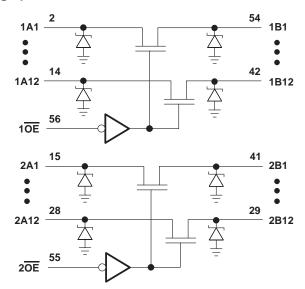
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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC}		
Input voltage range, V _I (see Note 1)		
Continuous channel current		
Input clamp current, I_{IK} (V _I < 0)		
Package thermal impedance, θ_{JA} (see Note 2):		
	DGV package	
	DL package	74°C/W
Storage temperature range, T _{stg}		65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
VCC	Supply voltage	4	5.5	V
VIH	High-level control input voltage	2		V
VIL	Low-level control input voltage		0.8	V
Т _А	Operating free-air temperature	-40	85	°C

NOTE 3: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP†	MAX	UNIT
VIK		V _{CC} = 4.5 V,	lj = -18 mA				-1.2	V
1.	Ι _{ΙL}	V _{CC} = 5.5 V,	V _I = GND				-1	μA
μ I	Чн	V _{CC} = 5.5 V,	V _I = 5.5 V				150	μΑ
ICC		V _{CC} = 5.5 V,	I _O = 0,	$V_I = V_{CC}$ or GND			3	μΑ
∆lcc‡	Control inputs	V _{CC} = 5.5 V,	One input at 3.4 V,	Other inputs at V_{CC} or GND			2.5	mA
Ci	Control inputs	V _I = 3 V or 0				3		pF
C _{io(OFF)}		V _O = 3 V or 0,	$\overline{OE} = V_{CC}$			5.5		pF
r _{on} §		$V_{CC} = 4 V,$ TYP at $V_{CC} = 4 V$	V _I = 2.4 V,	lı = 15 mA		14	20	
			V _I = 0	lı = 64 mA		5	7	Ω
		V _{CC} = 4.5 V		lı = 30 mA		5	7	
		V	V _I = 2.4 V,	l _l = 15 mA		8	12	

[†] All typical values are at V_{CC} = 5 V (unless otherwise noted), T_A = 25°C.

[‡] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND. § Measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lowest voltage of the two (A or B) terminals.

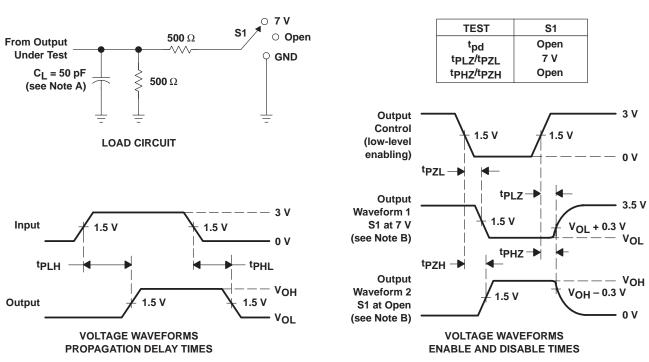
switching characteristics over recommended operating free-air temperature range, CL = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4 V	V _{CC} = 5 V ± 0.5 V		UNIT
	(INFOT)		MIN MAX	MIN	MAX	
t _{pd} ¶	A or B	B or A	0.35		0.25	ns
ten	OE	A or B	9.3	3.3	8.6	ns
tdis	OE	A or B	7.1	2.8	7.9	ns

The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).



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PARAMETER MEASUREMENT INFORMATION

NOTES: A. C_L includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_f \leq 2.5 ns, t_f \leq 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. tPLH and tPHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



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